

HSF

NOTES:

Current Rating: 1.0AMP

Contact Resistance: 20mΩ Max

Withstand Voltage: 500V AC/DC

Insulation Resistance: 1000MΩ Min

Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze

Contact plating: Au Or Sn over Ni

Insulator Material: PA9T+30%GF UL94V-0

Ordering Information

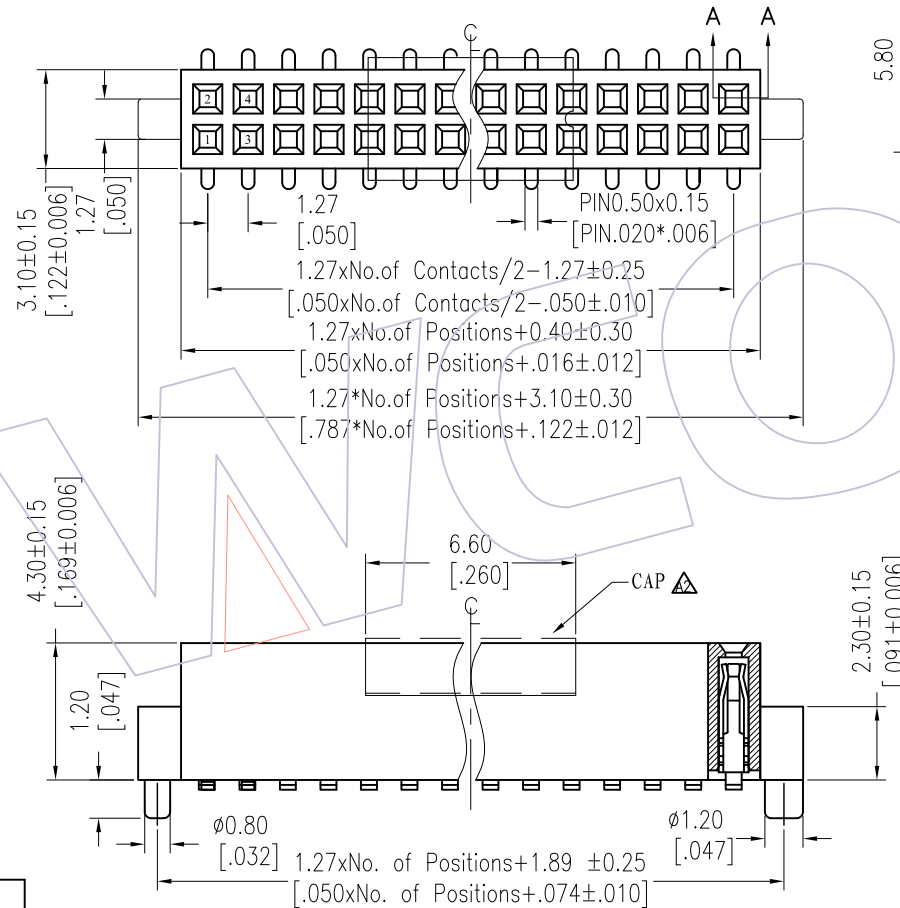
2344-2 XX M XX CUN X 3

No. of Pins per
Row: 02~50Pin

Contact Plating:
G0=Gold Flash
G3=10μ"Gold
G4=15μ"Gold
G5=30μ"Gold
S0=Gold Flash/Tin
S3=10μ"Gold/Tin
S4=15μ"Gold/Tin
S5=30μ"Gold/Tin
SN=Tin

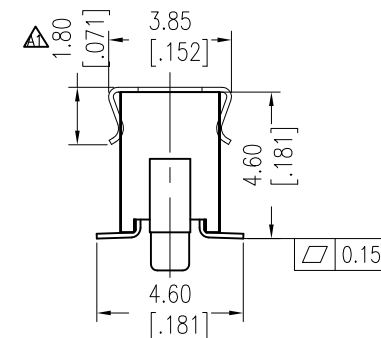
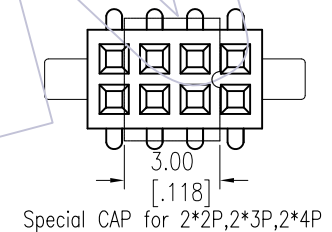
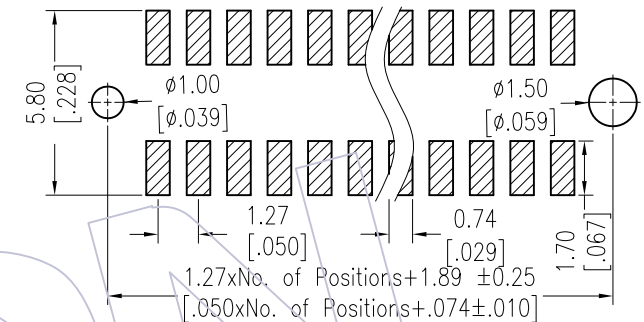
Packing:
T=Tube
P=Tube+CAP
R=Tape&Reel+CAP

Item	Pitch	Mating
Standard	1.27	310/1315/1320/3131/3133/3100
Alternate		



SECTION A-A

Recommended P.C.B Layout(Top Side) (PCB BOARD TOLERANCE±0.05)



REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.	TITLE:	Customer NO.
A2	2014/12/30	Modify CAP	-----	X.X ±0.40	Wang	2014/12/30	UNIT	mm	2344-2XXMXXCUNX3		
A1	2013/08/21	Modify cap 2.00 → 1.80	-----	X.XX ±0.25	CHECK	DATE	SIZE	A4		FH1.27mm DUAL SMT WITH DIFFERENT POST	
A0	2012/07/09	NEW	-----	X.XXX ±0.15	APPROVE	DATE	SHEET	1/1		H=4.30	
				Angle ± 3'			PROJ.				
				DIM TOL							